

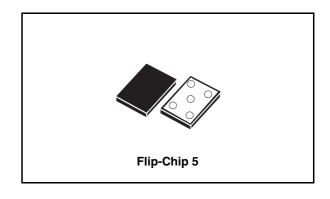
ST1G3234B

1-bit dual supply bus buffer level translator with A-side series resistor

Features

- High speed: t_{PD} = 4.0 ns (max.) at T_A = 85 °C V_{CCB} = 1.65 V; V_{CCA} = 3.0 V
- Low power dissipation:
 I_{CCA} = I_{CCB} = 5 μA (max.) at T_A = 85 °C
- Symmetrical output impedance:

 |IOHA| = IOLA = 10 mA min at
 |VCCA = 2.75 V; VCCB = 1.4 to 3.6 V
 |IOHA| = IOLA = 6 mA min. at
 |VCCA = 2.3 V; VCCB = 1.4 to 3.6 V
- Balanced propagation delays: t_{PLH} ≅ t_{PHL}
- Power-down protection on inputs and outputs
- 26 Ω series resistor on A-side outputs
- Operating voltage range:
 - V_{CCA} (opr.) = 1.4 to 3.6 V
 - V_{CCB} (opr.) = 1.4 to 3.6 V
- Allows partial power-down when V_{CCA} = 0, device consumes very low quiescent current
- Max data rates:
 - 380 Mbps (1.8 to 3.3 V translation)
 - 260 Mbps (<1.8 to 3.3 V translation)
 - 260 Mbps (translates to 2.5 V)
 - 210 Mbps (translates to 1.5 V)
- Latch-up performance exceeds 500 mA (JESD 17)
- ESD performance: HBM > 2000 V (MIL STD 883 method 3015); MM > 200 V
- R_OHS compliant to Flip-Chip package



Description

The ST1G3234B is a dual supply low voltage CMOS 1-bit bus buffer level translator fabricated with sub-micron silicon gate and five-layer metal wiring C²MOS technology. Designed for use as an interface between a 3.3 V bus and a 2.5 V or 1.8 V bus in a mixed 3.3 V/1.8 V, 3.3 V/2.5 V, 1.8 V/1.4 V and 2.5 V/1.8 V supply systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

The ST1G3234B is intended for one-way asynchronous communication between data buses. The input and output power-down protections disable the device when both power supply are down, so that the buses are effectively isolated.

The input tolerant buffers allow to translate V_{CCB} compatible signals and greater signals than V_{CCB} up/down to V_{CCA} . All inputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

The ST1G3234B is V_{CCA} = 0 V tolerant, achieving very low current consumption when the V_{CCA} is grounded.

Table 1. Device summary

Order code	Package	Comments		
ST1G3234BBJR	Flip-Chip 5	4000 parts per reel		

Contents ST1G3234B

Contents

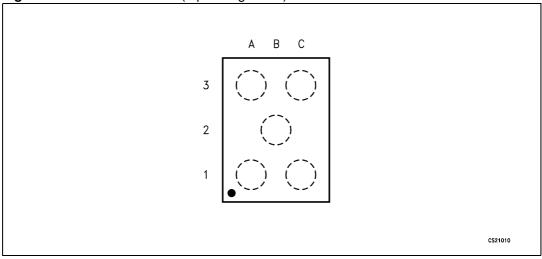
1	Pin settings 3
	1.1 Pin connection
	1.2 Pin description
2	Device summary4
3	Maximum rating
	3.1 Recommended operating conditions 6
4	Electrical characteristics
5	Test circuit
6	Waveforms
7	Package mechanical data
8	Revision history

ST1G3234B Pin settings

1 Pin settings

1.1 Pin connection

Figure 1. Pin connection (top through view)



1.2 Pin description

Table 2. Pin description

Pin number	Symbol	Name and function		
A1	A1	Data output (V _{CCA} referred)		
C1	B1 Data input (V _{CCB} refe			
B2	GND	Ground (0V)		
A3	V _{CCA}	Positive supply voltage		
C3	V _{CCB}	Positive supply voltage		

3/17

Device summary ST1G3234B

2 Device summary

Figure 2. Input equivalent circuit

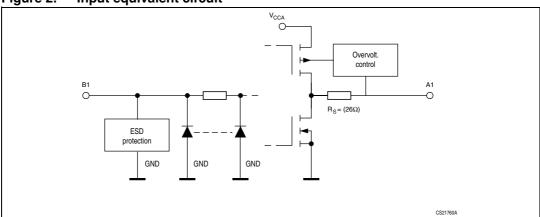


Figure 3. Logic diagram

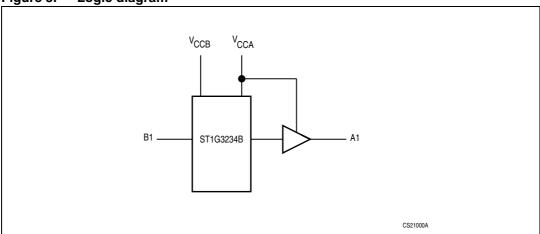


Table 3. Truth table

Inputs B1 (V _{CCB} referred)	Outputs A1 (V _{CCA} referred)
L	L
Н	Н

ST1G3234B Maximum rating

3 Maximum rating

Stressing the device above the rating listed in the "Absolute maximum ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CCA}	Output supply voltage	-0.5 to +4.6	V
V _{CCB}	Input supply voltage	-0.5 to + 4.6	V
V _{OA}	DC output voltage (power down mode: V _{CCA} =V _{CCB} =Gnd)	-0.5 to +4.6	V
V _{IB}	DC input voltage (power down mode: V _{CCA} =V _{CCB} =Gnd)	-0.5 to +4.6	V
V _{OA}	DC output voltage	-0.5 to V _{CCA} + 0.5	V
V _{IB}	DC input voltage	-0.5 to + 4.6	V
I _{IK}	DC input diode current	-20	mA
lok	DC output diode current	– 50	mA
I _{OA}	DC output current	±50	mA
I _{CCA}	DC V _{CCA} or ground current	±100	mA
I _{CCB}	DC V _{CCB} or ground current	±100	mA
P _d	Power dissipation	200	mW
T _{stg}	Storage temperature	-65 to +150	°C
T _L	Lead temperature (10 sec)	260	°C

5/17

Maximum rating ST1G3234B

3.1 Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Value	Unit	
V _{CCA}	Supply voltage		1.4 to 3.6	V
V _{CCB}	Supply voltage	Supply voltage		
V _{IB}	Input voltage (B1)	0 to V _{CCB}	V	
V _{OA}	Output voltage (A1)	0 to V _{CCA}	V	
T _{op}	Operating temperature		-40 to 85	°C
		$V_{CCB} = 3.0 \text{ to } 3.6 \text{ V}$	0 to 10	ns/V
dt/dv	Input rise and fall time	$V_{CCB} = 2.3 \text{ to } 2.7 \text{ V}$	0 to 20	ns/V
		V _{CCB} = 1.2 to 1.95 V	0 to 100	ns/V

4 Electrical characteristics

Table 6. DC specification

		Test condition		Value					
Symbol	Parameter	Voce	V _{CCA}		T _A = 2	25 °C	-40 to	85 °C	Unit
		V _{CCB} (V) ⁽¹⁾	(V) ⁽¹⁾		Min	Max	Min	Max	
		1.4			0.65 V _{CCB}		0.65 V _{CCB}		
V _{IHB}	High level	1.8	1.4 to		0.65 V _{CCB}		0.65 V _{CCB}		V
VIHB	input voltage	2.5	3.6		1.6		1.6		V
		3.3			2.0		2.0		
		1.4				0.35 V _{CCB}		0.35 V _{CC}	
V _{ILB}	Low level input voltage	1.8	1.4 to 3.6			0.35 V _{CCB}		0.35 V _{CC}	٧
	-	2.5				0.7		0.7	
		3.3				0.8		0.8	
			1.4	$I_{O} = -100 \mu A$	1.2		1.2		
			2.75	I _O = -10 mA	2.2		2.2		V
V _{OHA}	High level output voltage	1.4 to 3.6	2.3	$I_O = -6 \text{ mA}$	1.8		1.8		
			1.65	I _O = -2 mA	1.4		1.4		
			1.4	I _O = -1 mA	1.1		1.1		
			1.4	$I_{O} = -100 \mu A$		0.20		0.20	
			2.75	I _O = 1 mA		0.40		0.40	
V _{OLA}	Low level	1.4 to	2.75	I _O = 10 mA		0.55		0.55	V
VOLA	output voltage	3.6	2.3	$I_O = 6 \text{ mA}$		0.40		0.40	
			1.65	$I_O = 2 \text{ mA}$		0.25		0.25	
			1.4	$I_O = 1 \text{ mA}$		0.20		0.20	
	Input leakage	2.7	3.6	V _{IB} = V _{CCB} or GND		±0.5		±5	μΑ
l _{IB}	current	1.4	2.7	V _{IB} = 3.6 V or GND		±0.5		±5	μА
I _{OFF}	Power OFF leakage current	0	0	V _{IB} = GND to 3.6 V V _{OA} = GND to 3.6 V		±1.0		±10	μА

577

Electrical characteristics ST1G3234B

Table 6. DC specification (continued)

Symbol Parameter		Test condition			Value					
		V _{CCB} V _{CCA}			T _A = 25 °C		-40 to 85 °C		Unit	
	$\begin{array}{c c} \mathbf{V}_{\mathbf{CCB}} & \mathbf{V}_{\mathbf{CCA}} \\ \mathbf{V}^{(1)} & \mathbf{V}^{(1)} \end{array}$			Min	Max	Min	Max			
1	Quiescent		1.4 to 3.6	$V_{IB} = V_{CCB}$		0.5		5		
ІССВ	supply current	1.4 to 3.6	4 to or GNI	or GND	or GND		0.5		3	μА
I _{CCA}	Quiescent supply current	1.4 to 3.6	1.4 to 3.6	V _{IB} =V _{CCB} or GND		0.5		5	μА	

^{1.} V_{CC} range = 1.8 ± 0.15 V; 2.5 ± 0.2 V; 3.3 ± 0.3 V

Table 7. AC electrical characteristics

			Value				
Symbol	Parameter	V _{CCB}	V _{CCA}		-40 to	85 °C	Unit
		(V)	(V)		Min	Max	
		2.3 to 3.6	1.4		2.0	5.0	
		1.4 to 1.95	1.4		2.0	5.0	
		2.3 to 3.6	1.65 to 1.95		2.0	4.5	
t _{PLH} t _{PHL}	Propagation delay time B1 to A1	1.4 to 1.95	1.65 to 1.95	C _L = 10 pF	2.0	4.8	ns
		1.4 to 1.95	2.3 to 2.7		2.0	3.5	
		1.4 to 1.95	3.0 to 3.6		2.0	3.5	
		2.3 to 2.7	3.0 to 3.6		1.0	3.0	
		2.3 to 3.6	1.4		2.0	5.5	
		1.4 to 1.95	1.4	$C_L = 30 \text{ pF}$ $R_L = 500 \Omega$	2.0	5.5	ns
		2.3 to 3.6	1.65 to 1.95		2.0	5.0	
t _{PLH} t _{PHL}	Propagation delay time B1 to A1	1.4 to 1.95	1.65 to 1.95		2.0	5.2	
		1.4 to 1.95	2.3 to 2.7		2.0	4.0	
		1.4 to 1.95	3.0 to 3.6		2.0	4.0	
		2.3 to 2.7	3.0 to 3.6		1.0	3.5	

Table 8. Capacitance characteristics

		Test condition			Value					
Symbol	Parameter	V _{CCB}	CCB VCCA		T _A = 25 °C			-40 to 85 °C		Unit
	(V)	(V)		Min	Тур	Max	Min	Max		
C _{INB}	Input capacitance	open	open			5				pF
Co	Output capacitance	2.5	3.3			6				pF
		2.5	3.3			27				
		1.8	3.3			27				
C _{PD} Power dissipation capacitance	1.4	2.5	f = 10 MHz		23				pF	
	3	1.4	1.8		20					
		3.3	1.8			27				

Note: 1 C_{PD} is defined as the value of the device's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average current can be obtained by the following equation: $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/4$ (per circuit)

Test circuit ST1G3234B

5 Test circuit

Figure 4. Test circuit

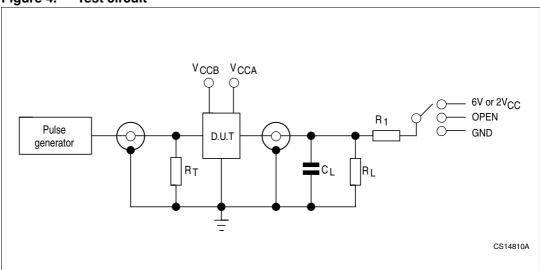


Table 9. Test circuit

Test	Switch
t _{PLH} , t _{PHL}	Open

 $C_L = 10/30 \ pF$ or equivalent (includes jig and probe capacitance)

 $R_L = R_1 = 500 \,\Omega$ or equivalent

 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω)

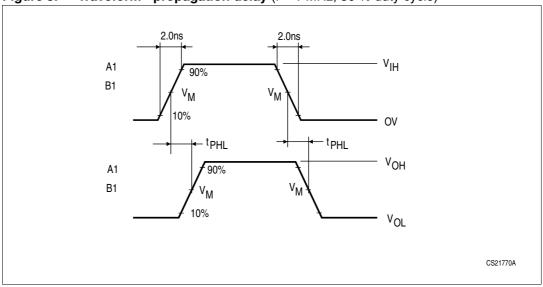
ST1G3234B Waveforms

6 Waveforms

Table 10. Waveform symbol value

Symbol	V _{CC}						
Symbol	3.0 to 3.6 V	2.3 to 2.7 V	1.65 to 1.95 V				
V _{IH}	V _{CC}	V _{CC}	V _{CC}				
V_{M}	1.5 V	V _{CC} /2	V _{CC} /2				

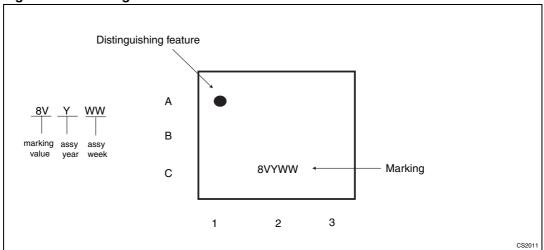
Figure 5. Waveform - propagation delay (f = 1 MHz; 50 % duty cycle)



7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Figure 6. Marking



TOP VIEW Øb <u>Al see note 1</u> BOTTOM VIEW

Figure 7. Flip-Chip 5 package outline

577

Table 11. Flip-Chip 5 mechanical data

	- пр отпр о					
Symbol	millimeters			mils		
	Min	Тур	Max	Min	Тур	Max
Α	0.585	0.65	0.714	23.0	25.6	28.1
A1	0.21	0.25	0.29	8.3	9.8	11.4
a2		0.40			15.7	
b	0.265	0.315	0.365	10.4	12.4	14.4
D	1.31	1.36	1.41	51.6	53.5	55.5
D1		9.866			34.1	
E	0.97	1.02	1.07	38.2	40.2	42.1
E1		0.5			19.7	
eD	0.383	0.433	0.483	15.1	17.0	19.0
eE	0.20	0.25	0.30	7.9	9.8	11.8
fD		0.247			9.7	
fE		0.260			10.2	
ccc		0.080			3.1	

A PO Note: Drawing not in scale

Figure 8. Flip-Chip 5 tape and reel information

1. Drawing not to scale.

Table 12. Flip-Chip 5 tape and reel mechanical data

Symbol	millimeters			inches		
	Min	Тур	Max	Min	Тур	Max
Α			178			6.926
С	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	49	50	51	1.929	1.969	2.008
Т			12.4			0.488
Ao	1.60	1.65	1.70	0.063	0.065	0.067
Во	1.27	1.32	1.37	0.050	0.052	0.054
Ko	0.76	0.81	0.86	0.030	0.032	0.034
Po	3.9	4	4.1	0.153	0.157	0.161
Р	3.9	4	4.1	0.153	0.157	0.161

577

Revision history ST1G3234B

8 Revision history

Table 13. Document revision history

Date	Revision	Changes
1-Aug-2007	1	Initial release.
3-Dec-2007	2	Changed t_{PD} value from 4.4 ns to 4.0 ns, removed footnote in <i>Table 5:</i> Recommended operating conditions on page 6, updated V_{OLA} value at $V_{CCA} = 1.4$ V, changed symbol names for quiescient supply current and minor text changes in <i>Table 6: DC specification on page 7</i> , removed V_x and V_y waveforms data in <i>Table 10: Waveform symbol value on page 11</i> , replaced Figure 6: Marking on page 12 and enlarged Figure 7: Flip-Chip 5 package outline on page 13 to improve readability.

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